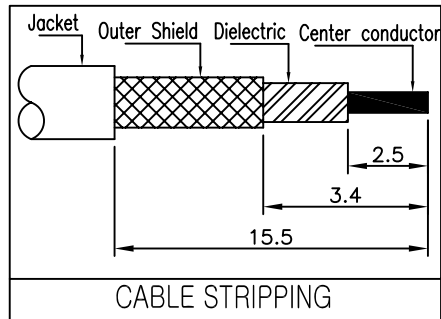
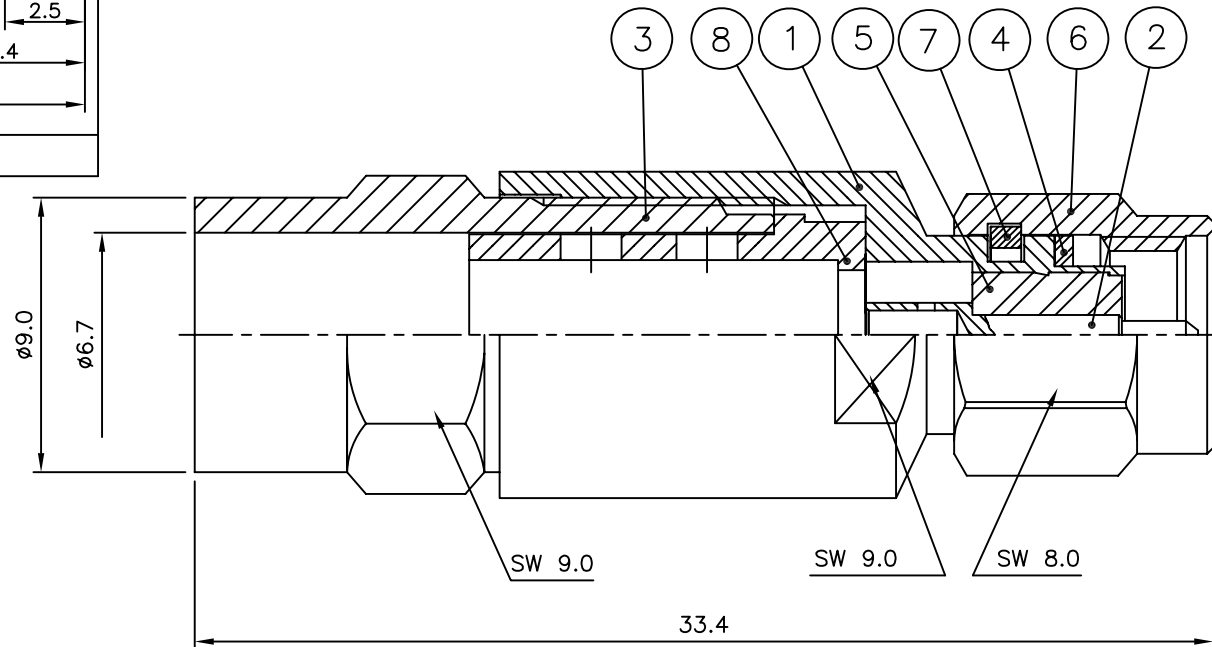




REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	G.Y.KIM	I.C.KIM	2016. 12. 20.

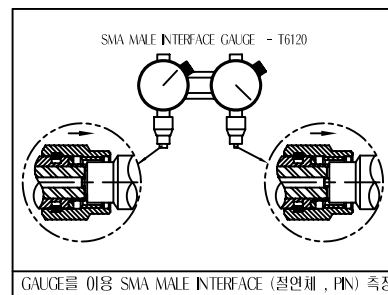
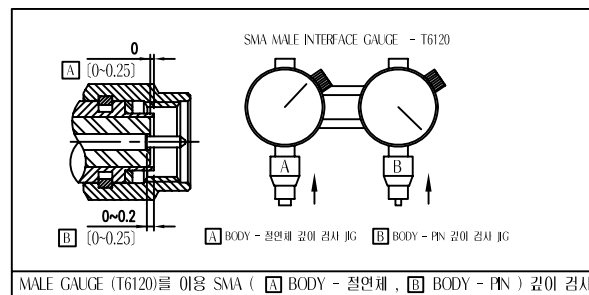


*조립방법

1. ①번 BODY에 ⑤번 TEFLON을 조립한다.
2. ①번 BODY에 ④번 GASKET, ⑦번 SPRING RING을 조립한다.
3. ⑥번 CAP을 조립한다.
4. ①번 BODY와 ⑧번 INSERT, ③번 CLAMP를 체결하여 포장한다.

*결합도 2PAGE 참조

NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE
8	INSERT	1	MBsBD C3604BD-F	Gold Plate	DIS00258-5/1
7	SPRING RING	1	MBsBD C3604BD-F	Passivated	DSR00002-5/1
6	COUPLING CAP	1	SUS	Passivated	DCU00006-5/1
5	INSULATOR	1	TEFLON		DIN02863-N/1
4	GASKET	1	SILICONE	Red	DGK00004-N/1
3	CLAMP	1	MBsBD C3604BD-F	Nickel Plate	DIS00260-5/1
2	CONTACT	1	MBsBD C3604BD-F	Gold Plate	DCT03796-5/1
1	BODY	1	MBsBD C3604BD-F	Nickel Plate	DBD04272-5/1



TOLERANCE	Decimal ± 0.1 Angle $\pm 1^\circ$	DATE 2016. 12. 20.
MATERIAL	APPROVED BY I.C.KIM	CHECKED BY C.K.KIM
FINISH	DRAWN BY G.Y.KIM	SCALE 4/1
	UNIT mm	REVISION I R

		RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
KJ COMTECH CO.,LTD.		TITLE SMA(~27GHz) CABLE PS EXLH-21r
DWG NO. CN03667-7/1		SHEET 1 of 1

